3.0x2.0mm SURFACE MOUNT LED LAMP

WARM WHITE

PRELIMINARY SPEC



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Features

- 3.0MM X 2.0MM, 1.3MM HIGH, ONLY MINIMUM SPACE REQUIRED.
- SUITABLE FOR COMPACT OPTOELECTRONIC APPLICATIONS.
- LOW POWER CONSUMPTION.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 4.
- ELECTROSTATIC DISCHARGE THRESHOLD (HBM):1000V.
- TYP. COLOR TEMPERATURE: 3400K
- COLOR COORDINATES:X=0.41,Y=0.39 ACC. TO
- OPTICAL EFFICIENCY: 31.3 lm/W(TYP.)
- COLOR REPRODUCTION INDEX: 70
- RoHS COMPLIANT.

Description

The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

Part Number: AA3021PR4S/Z

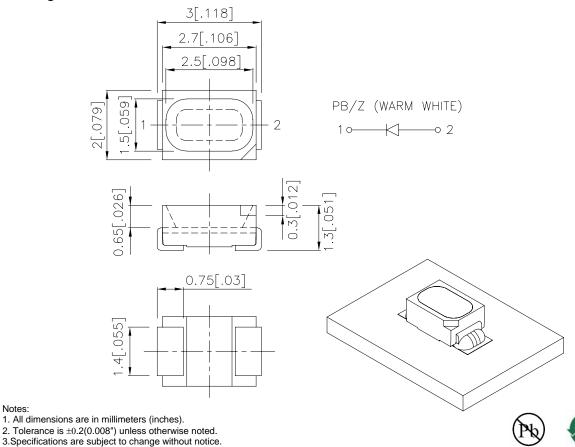
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Applications

- traffic signaling.
- backlighting (illuminated advertising, general lighting).
- interior and exterior automotive lighting.
- substitution of micro incandescent lamps.
- reading lamps.
- signal and symbol luminaire for orientation.
- marker lights (e.g. steps, exit ways, etc).
- decorative and entertainment lighting.
- indoor and outdoor commercial and residential architectural lighting.

Package Dimensions



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Notes:

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4. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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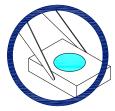
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Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

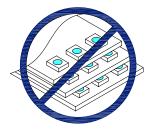


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

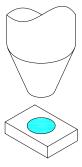




3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



4. During surface-mounting, the pickup capillary diameter should be larger than the silicone lens to insure the capillary does not scratch or damage the lens.



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Selection Guide

Part No.	Dice	Lens Type	luminous Intensity Note2 Iv(mcd) @ 20mA		Φν (mlm) Note3 @ 20mA	Viewing Angle Note1
			Min.	Тур.	Тур.	201/2
AA3021PR4S/Z	WARM WHITE (InGaN)	WATER CLEAR	480	600	2000	125°

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pt	111	mW
Reverse Voltage	VR	5	V
Junction temperature	TJ	110	°C
Operating Temperature	Тор	-40 To +85	°C
Storage Temperature	Tstg	-40 To +100	°C
DC Forward Current	lF	30	mA
Peak Forward Current Note4	Іғм	100	mA
Thermal resistance Junction/ambient Note5 Junction/solder point	Rth JA Rth JS	250 100	°C/W °C/W

Notes:

- 1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.Luminous intensity is measured by a current pulse of 10ms at a tolerance of $\pm 15\%$.
- 3.The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.
- 4.1/10 Duty Cycle, 0.1ms Pulse Width.
- 5.Rth(J-A) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit
Chromaticity coordinate x acc.to CIE1931 IF=20mA [Typ.]	Х	0.41	-
Chromaticity coordinate y acc.to CIE1931 IF=20mA [Typ.]	Y	0.39	-
Forward Voltage IF=20mA [Min.]		2.7	V
Forward Voltage IF=20mA [Typ.]	V _F Note1	3.2	
Forward Voltage IF=20mA [Max.]		3.7	
Reverse Current (VR=5V) [Typ.]	l _R	0.01	
Reverse Current (VR=5V) [Max.]	IR IR	10	μΑ
Temperature coefficient of x IF=20mA, -10°C≤ T≤100°C [Typ.]	TCx	-0.1	10 ⁻³ /°C
Temperature coefficient of y IF=20mA, -10°C≤ T≤100°C [Typ.]	ТСу	-0.2	10 ⁻³ /°C
Temperature coefficient of VF IF=20mA, -10°C≤ T≤100°C [Typ.]	TCv	-2.5	mV/°C

Note:

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^{1.} Forward voltage is measured with a current pulse of 10ms at a tolerance of ± 0.1 V.

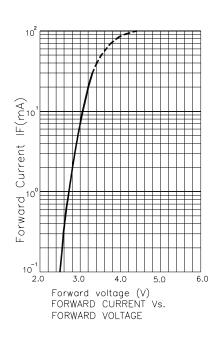
Brightness codes

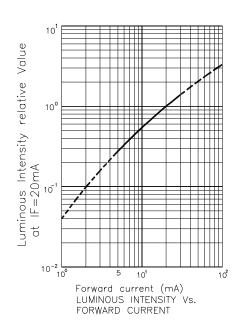
luminous Intensity ^{Note1} Iv(mcd) @ 20mA			Φν (mlm) ^{Note2} @ 20mA
Code.	Min.	Max.	Тур.
S	480	750	1900
Т	650	1100	2100
U	900	1500	2300

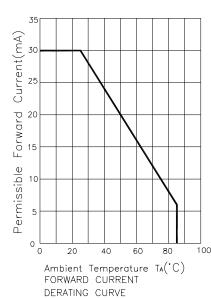
Notes:

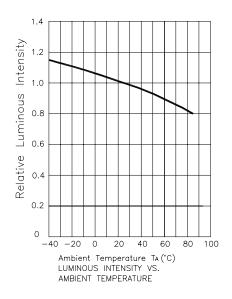
Warm White

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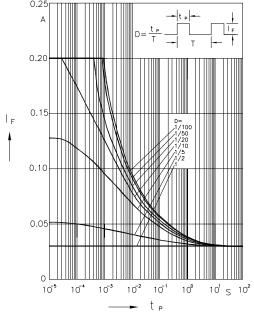
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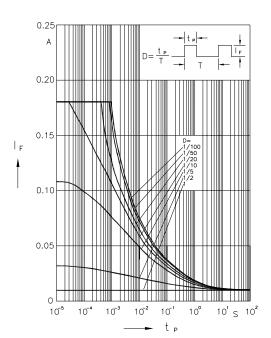
^{1.}Luminous intensity is measured by a current pulse of 10ms at a tolerance of $\pm 15\%$.

^{2.} The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.

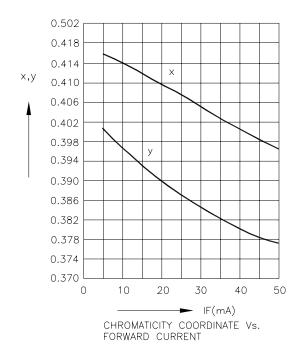
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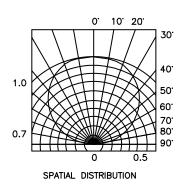


Permissible Pulse Handling Capability Duty cycle D=parameter,TA=25°C



Permissible Pulse Handling Capability Duty cycle D=parameter,TA=85°C



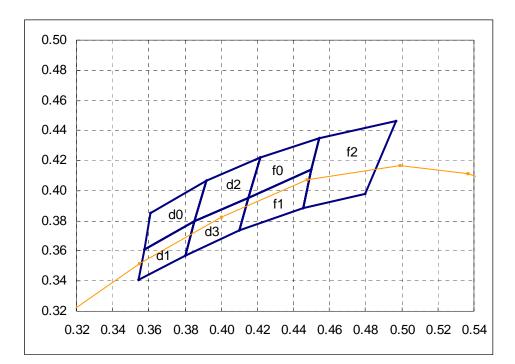


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AA3021PR4S/Z

Warm White CIE



d0					
Х	0.3610	0.3575	0.3870	0.3942	
у	0.3850	0.3612	0.3820	0.4068	
F	Reference CCT: 4700~3900K				
d2					
Х	0.3870	0.4254	0.4350	0.3942	
у	0.3820	0.4044	0.4260	0.4068	
Reference CCT: 3900~3200K					
fO					
х	0.4350	0.4732	0.4600	0.4254	
у	0.4260	0.4398	0.4152	0.4044	
Reference CCT: 3200~2700K					

0.4600

0.4152

0.4440

0.3847

Reference CCT: 2700~2300K

0.4800

0.3960

0.5165

0.4510

0.4732

0.4398

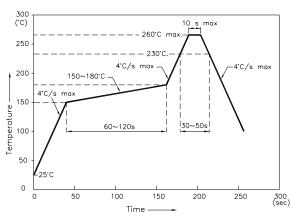
d1					
х	0.3575	0.3545	0.3800	0.3870	
У	0.3612	0.3408	0.3580	0.3820	
F	Reference CCT: 4700~3900K				
d3					
х	0.4254	0.3870	0.3800	0.4119	
у	0.4044	0.3820	0.3580	0.3730	
F	Reference CCT: 3900~3200K				
f1					
х	0.4600	0.4254	0.4119	0.4440	
у	0.4152	0.4044	0.3730	0.3847	
Reference CCT: 3200~2700K					

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Reflow Soldering Profile For Lead-free SMT Process.

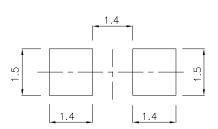


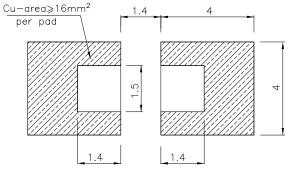
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)

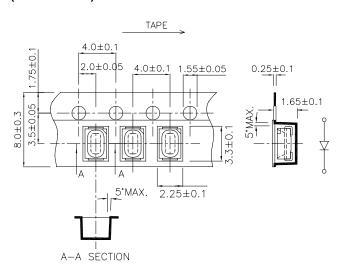
Pad design for improved heat dissipation



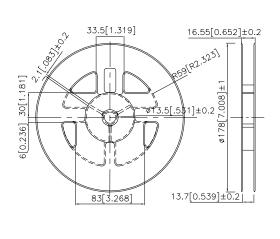


Solder resist

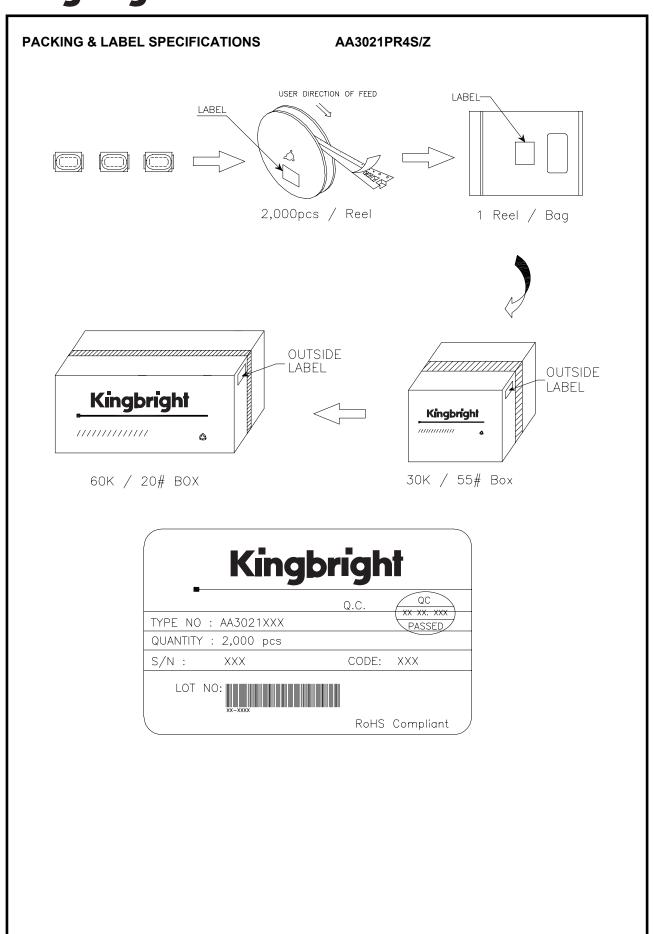
Tape Specifications (Units: mm)



Reel Dimension



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